

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|--|---|------------------|---------|------------------|
| S1 | 2 | ((("6255195") or ("6825532"))).PN. | USPAT | OR | OFF | 2005/09/13 10:27 |
| S2 | 1 | ("6083324").PN. | USPAT | OR | OFF | 2005/09/12 18:06 |
| S3 | 5 | ((("5334273") or ("5374564") or ("5661044") or ("5731637") or ("5882987"))).PN. | USPAT | OR | OFF | 2005/09/12 18:21 |
| S4 | 626 | gettering with implant\$5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/09/12 18:23 |
| S5 | 27 | S4 and ((donar or support or handle) with wafer) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/09/12 18:34 |
| S6 | 161 | 438/473.ccls. | US-PGPUB; USPAT | OR | ON | 2005/09/12 18:34 |
| S7 | 913 | 438/58,143,310,402,471-476.ccls. | US-PGPUB; USPAT | OR | ON | 2005/09/13 10:28 |
| S8 | 91 | S7 and implant\$5 and bond and ((handle or support or donor or second) with (substrate or wafer)) | US-PGPUB; USPAT | OR | ON | 2005/09/13 10:29 |
| S9 | 137 | S7 and implant\$5 and bond\$3 and ((handle or support or donor or second) with (substrate or wafer)) | US-PGPUB; USPAT | OR | ON | 2005/09/13 11:35 |
| S10 | 1 | ("6162705").PN. | USPAT | OR | OFF | 2005/09/13 11:35 |
| S11 | 1239 | 438/455,473.ccls. | US-PGPUB; USPAT | OR | ON | 2006/01/08 14:32 |

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|-------|------|---|----------|------------------|---------|------------------|
| L1 | 2 | (implant\$4 and (semiconductor or wafer) and ((select\$3 or known or measur\$3) with depth) and (form\$3 with (amorphous or non\$crystalline)) and (heating or annealing) and (bonding with (handle or second or receiving) with wafer)).CLM. | US-PGPUB | OR | ON | 2006/01/08 15:28 |